

## Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

### **Product image**





## **OMNIMATE<sup>®</sup> 4.0 - the next evolution step**

OMNIMATE<sup>®</sup> 4.0 follows the trend of One Cable Technology (OCT). The modular concept enables the fast configuration of hybrid interfaces, which transmit data, signals and energy in a single connector. As a result, you can reduce the cabling effort in a wide variety of applications, simplify maintenance and accelerate automation processes. The unique SNAP IN connection is the backbone and speeds up the wiring process.

#### The fastest connection yet

- Fast, safe, and tool-free wiring due to unique SNAP IN connection
- Ready for Robot through "wire ready" delivery with open clamping point
- Optical and acoustic feedback indicates proper wiring
- **Create your own configuration**
- Flexible configuration and ordering via the Weidmüller Configurator (WMC)
- Dispatch within three days even for individually configured products
- Automatic offer preparation for the configurated product

# Simply configuration of modular hybrid connectors

• Flexible combination options for power, signal and data transmission

• Future-proof Single-Pair Ethernet technology

#### **General ordering data**

Version	PCB plug-in connector, male header, THT/THR solder connection, Pitch in mm (P): 5.00 mm, Number of poles: 5, 180°, Tube
Order No.	<u>8000072435</u>
Туре	MHS 5/05 V T3 B T
GTIN (EAN)	4064675423102
Qty.	20 pc(s).
Product data	IEC: 400 V / 25.3 A UL: 300 V / 18.5 A
Packaging	Tube

Creation date August 27, 2023 4:58:27 AM CEST

# **Technical data**



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Depth	11.9 mm	Depth (inches)	0.469 inch
Height	17.2 mm	Height (inches)	0.677 inch
Height of lowest version	14 mm	Width	26.38 mm
Width (inches)	1.039 inch	Net weight	4.188 g
Temperatures			
Operating temperature, min.	-50 °C	Operating temperature, max.	100 °C
System specifications			
Due du sé ferreille		Time of compaction	De and a sur a stir a
Product family	OMNIMATE 4.0	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	5 mm
Pitch in inches (P)	0.197 inch	Outgoing elbow	180°
Number of poles	5	Number of solder pins per pole	1
Solder pin length (I)	3.2 mm	Solder pin dimensions	1.0 x 1.0 mm
Solder eyelet hole diameter (D)	1.4 mm	Solder eyelet hole diameter tolerance (E	
Outside diameter of solder pad	2.3 mm	Template aperture diameter	2.1 mm
L1 in mm	20 mm	L1 in inches	0.787 inch
Number of rows	1	Pin series quantity	1
Touch-safe protection acc. to DIN VDE 57 106	Touch-safe above the printed circuit board	Touch-safe protection acc. to DIN VDE 0470	IP 20
Protection degree	IP20	Volume resistance	≤5 mΩ
Plugging cycles	≥ 25	Plugging force/pole, max.	8.5 N
Pulling force/pole, max.	8.5 N		
Material data			
	DA OT		
Insulating material	PA 9T	Colour	black I
Colour chart (similar)	RAL 9011	Insulating material group	1
Comparative Tracking Index (CTI)	≥ 600 V-0	Moisture Level (MSL)	•
UL 94 flammability rating Contact material	CuMg	Contact base material Contact surface	CuMg tinned
Tinning type	matt	Storage temperature, min.	-25 °C
Storage temperature, max.	55 °C	Operating temperature, min.	-25 C -50 °C
Operating temperature, max.	100 °C		
Rated data acc. to IEC			
tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	25.3 A
Rated current, max. number of poles (Tu=20°C)	20.8 A	Rated current, min. number of poles (Tu=40°C)	21.8 A
Rated current, max. number of poles (Tu=40°C)	18 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV	Clearance, min.	4 mm
Creepage distance, min.	5.4 mm		

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Institute (cURus)	c <b>R</b> us	Certificate No. (cURus)	E60693
Rated voltage (Use group B / UL 1059	) 300 V	Rated voltage (Use group D / UL 1059)	
Rated voltage (Use group F / UL 1059		Rated current (Use group B / UL 1059)	
Rated current (Use group D / UL 1059		Clearance distance, min.	4 mm
Creepage distance, min.	<b>5</b> 0 mm	Reference to approval values	Specifications are maximum values, details
ol 'r' /'	5.6 mm		see approval certificate.
Classifications			
ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
ECLASS 11.0	27-46-02-01	ECLASS 12.0	27-46-02-01
Important note			
		ly with the assured properties in the data sheet	
Votes	<ul> <li>in accordance with IPC-A-610<sup>10</sup>C</li> <li>Rated current related to rated</li> <li>P on drawing = pitch</li> <li>Rated data refer only to the cobe designed in accordance w</li> <li>Diameter of solder eyelet D =</li> </ul>	by with the assured properties in the data sheet Class 2". Further claims on the products can be cross-section & min. No. of poles. The properties of the product of the pr	resp. fulfill decorative propertievaluated on request.
Notes	<ul> <li>in accordance with IPC-A-610<sup>10</sup>C</li> <li>Rated current related to rated</li> <li>P on drawing = pitch</li> <li>Rated data refer only to the cobe designed in accordance w</li> <li>Diameter of solder eyelet D =</li> </ul>	ly with the assured properties in the data sheet Class 2". Further claims on the products can be cross-section & min. No. of poles. proponent itself. Clearance and creepage distant ith the relevant application standards.	resp. fulfill decorative propertie evaluated on request.
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Approvals Approvals JL File Number Search	<ul> <li>in accordance with IPC-A-610<sup>Tr</sup>C</li> <li>Rated current related to rated</li> <li>P on drawing = pitch</li> <li>Rated data refer only to the cobe designed in accordance w</li> <li>Diameter of solder eyelet D =</li> <li>Long term storage of the procession</li> </ul>	ly with the assured properties in the data sheet Class 2". Further claims on the products can be cross-section & min. No. of poles. omponent itself. Clearance and creepage distan- ith the relevant application standards. 1.4+0.1mm fuct with average temperature of 50 °C and ave	resp. fulfill decorative propertie evaluated on request.
Approvals Approvals UL File Number Search Certificate No. (cURus)	<ul> <li>in accordance with IPC-A-610<sup>10</sup>C</li> <li>Rated current related to rated</li> <li>P on drawing = pitch</li> <li>Rated data refer only to the cobe designed in accordance w</li> <li>Diameter of solder eyelet D =</li> <li>Long term storage of the procession</li> </ul>	ly with the assured properties in the data sheet Class 2". Further claims on the products can be cross-section & min. No. of poles. omponent itself. Clearance and creepage distan- ith the relevant application standards. 1.4+0.1mm fuct with average temperature of 50 °C and ave	resp. fulfill decorative propertievaluated on request.
Approvals Approvals JL File Number Search Certificate No. (cURus) Downloads Approval/Certificate/Document of	in accordance with IPC-A-610 <sup>T</sup> C Rated current related to rated P on drawing = pitch Rated data refer only to the co be designed in accordance w Diameter of solder eyelet D = Long term storage of the proc UL Website E60693	ly with the assured properties in the data sheet Class 2". Further claims on the products can be of cross-section & min. No. of poles. Imponent itself. Clearance and creepage distan- ith the relevant application standards. 1.4+0.1mm duct with average temperature of 50 °C and aver	resp. fulfill decorative properti evaluated on request. ces to other components are t
Notes Approvals Approvals UL File Number Search Certificate No. (cURus) Downloads Approval/Certificate/Document of Conformity Engineering Data	<ul> <li>in accordance with IPC-A-610<sup>10</sup>C</li> <li>Rated current related to rated</li> <li>P on drawing = pitch</li> <li>Rated data refer only to the cobe designed in accordance w</li> <li>Diameter of solder eyelet D =</li> <li>Long term storage of the procession</li> </ul>	ly with the assured properties in the data sheet Class 2". Further claims on the products can be of cross-section & min. No. of poles. Imponent itself. Clearance and creepage distan- ith the relevant application standards. 1.4+0.1mm duct with average temperature of 50 °C and aver	resp. fulfill decorative properti evaluated on request. ces to other components are t

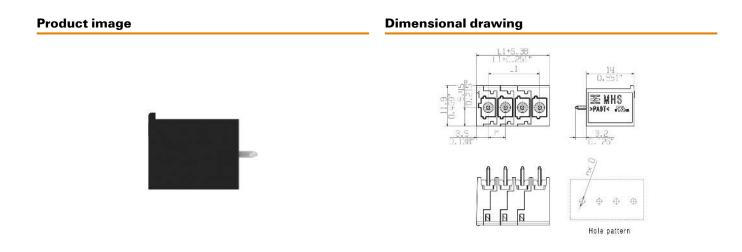
## Drawings



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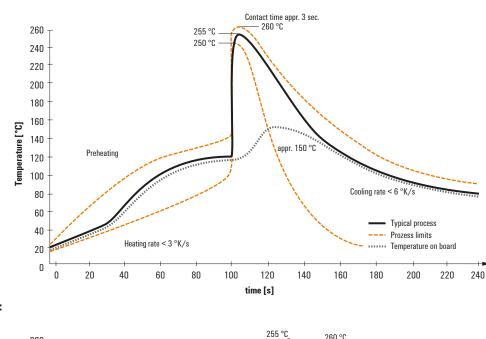
## Wave Solder Profile

## **Recommended wave solderding profiles**

# Weidmüller 🟵

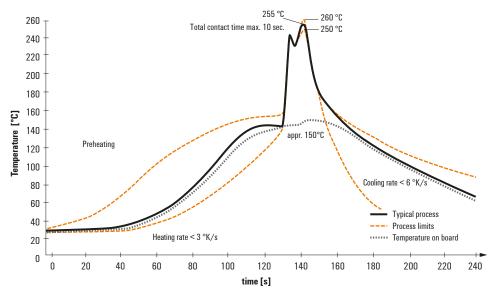
#### Weidmüller Interface GmbH & Co. KG

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**Double Wave:** 

Single Wave:



#### Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

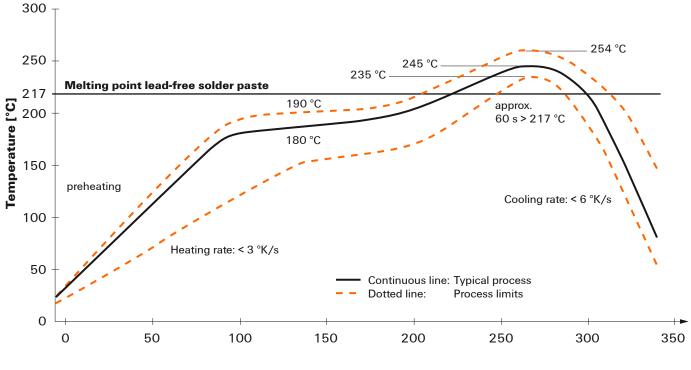
# **Reflow Solder Profile**

## **Recommended reflow soldering profile**



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Time [sec]

### **Reflow soldering profile**

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq$  -6K/s solder is cured. Board and components cool down while avoiding cold cracks.